

**PRELIMINARY**

# IRG4PH40UD

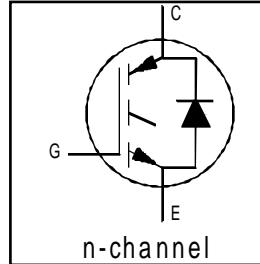
## INSULATED GATE BIPOLEAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

### Features

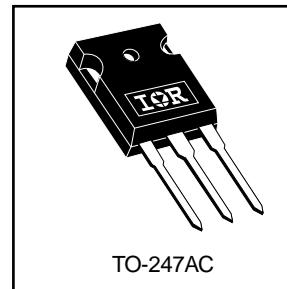
- UltraFast: Optimized for high operating frequencies up to 40 kHz in hard switching, >200 kHz in resonant mode
- New IGBT design provides tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-247AC package

### Benefits

- Higher switching frequency capability than competitive IGBTs
- Highest efficiency available
- HEXFRED diodes optimized for performance with IGBT's. Minimized recovery characteristics require less/no snubbing



$V_{CES} = 1200V$   
 $V_{CE(on)} \text{ typ.} = 2.65V$   
 $@V_{GE} = 15V, I_C = 15A$



### Absolute Maximum Ratings

	Parameter	Max.	Units
$V_{CES}$	Collector-to-Emitter Breakdown Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	30	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	15	
$I_{CM}$	Pulsed Collector Current ①	120	
$I_{LM}$	Clamped Inductive Load Current ②	120	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	8.0	
$I_{FM}$	Diode Maximum Forward Current	130	
$V_{GE}$	Gate-to-Emitter Voltage	$\pm 20$	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	160	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	65	
$T_J$	Operating Junction and Storage Temperature Range	-55 to + 150	$^\circ C$
$T_{STG}$	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm) from case )	
	Mounting torque, 6-32 or M3 screw.	10 lbf·in (1.1N·m)	

### Thermal Resistance

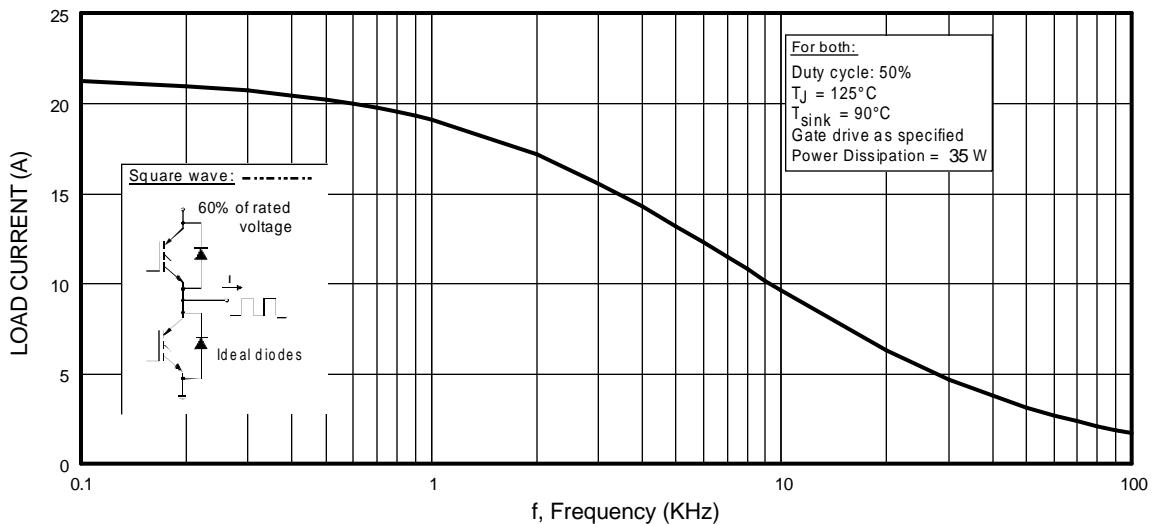
	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	—	0.77	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case - Diode	—	—	1.7	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
$Wt$	Weight	—	6 (0.21)	—	g (oz)

**Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

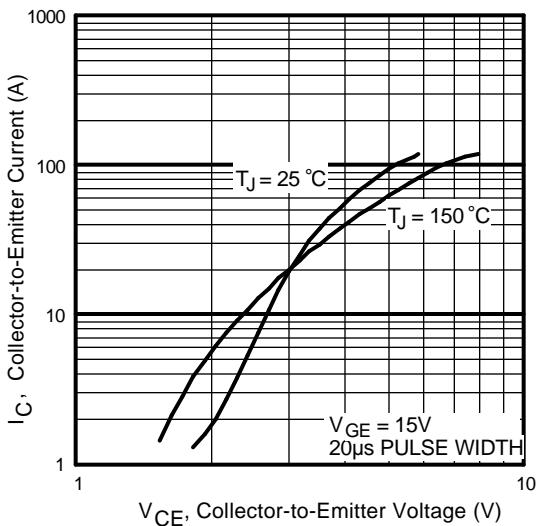
	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage <sup>③</sup>	1200	—	—	V	$V_{\text{GE}} = 0\text{V}$ , $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	0.43	—	$\text{V}^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$ , $I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	2.65	3.5	V	$I_C = 15\text{A}$
		—	3.08	—		$I_C = 30\text{A}$
		—	2.46	—		$I_C = 15\text{A}$ , $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-11	—	$\text{mV}^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$ , $I_C = 250\mu\text{A}$
$g_{\text{fe}}$	Forward Transconductance <sup>④</sup>	14	20	—	S	$V_{\text{CE}} = 100\text{V}$ , $I_C = 15\text{A}$
$I_{\text{CES}}$	Zero Gate Voltage Collector Current	—	—	250	$\mu\text{A}$	$V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 1200\text{V}$
		—	—	5000		$V_{\text{GE}} = 0\text{V}$ , $V_{\text{CE}} = 1200\text{V}$ , $T_J = 150^\circ\text{C}$
$V_{\text{FM}}$	Diode Forward Voltage Drop	—	2.6	3.5	V	$I_C = 8.0\text{A}$
		—	2.4	3.1		$I_C = 12\text{A}$ , $T_J = 150^\circ\text{C}$
$I_{\text{GES}}$	Gate-to-Emitter Leakage Current	—	—	$\pm 100$	nA	$V_{\text{GE}} = \pm 20\text{V}$

**Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)**

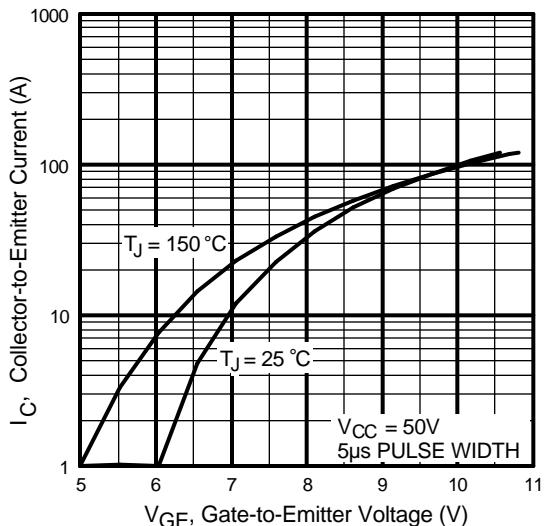
	Parameter	Min.	Typ.	Max.	Units	Conditions
$Q_g$	Total Gate Charge (turn-on)	—	86	130	nC	$I_C = 21\text{A}$
$Q_{\text{ge}}$	Gate - Emitter Charge (turn-on)	—	13	20		$V_{\text{CC}} = 400\text{V}$
$Q_{\text{gc}}$	Gate - Collector Charge (turn-on)	—	29	44		$V_{\text{GE}} = 15\text{V}$
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	37	—	ns	$T_J = 25^\circ\text{C}$
$t_r$	Rise Time	—	59	—		$I_C = 15\text{A}$ , $V_{\text{CC}} = 800\text{V}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	180	270		$V_{\text{GE}} = 15\text{V}$ , $R_G = 10\Omega$
$t_f$	Fall Time	—	100	150		Energy losses include "tail" and diode reverse recovery. See Fig. 9, 10, 18
$E_{\text{on}}$	Turn-On Switching Loss	—	1.50	—	mJ	
$E_{\text{off}}$	Turn-Off Switching Loss	—	0.81	—		
$E_{\text{ts}}$	Total Switching Loss	—	2.31	3.3		
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	39	—	ns	$T_J = 150^\circ\text{C}$ , See Fig. 11, 18
$t_r$	Rise Time	—	55	—		$I_C = 15\text{A}$ , $V_{\text{CC}} = 800\text{V}$
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	360	—		$V_{\text{GE}} = 15\text{V}$ , $R_G = 10\Omega$
$t_f$	Fall Time	—	250	—		Energy losses include "tail" and diode reverse recovery.
$E_{\text{ts}}$	Total Switching Loss	—	4.46	—	mJ	
$L_E$	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
$C_{\text{ies}}$	Input Capacitance	—	1800	—	pF	$V_{\text{GE}} = 0\text{V}$
$C_{\text{oes}}$	Output Capacitance	—	120	—		$V_{\text{CC}} = 30\text{V}$
$C_{\text{res}}$	Reverse Transfer Capacitance	—	18	—		See Fig. 7 $f = 1.0\text{MHz}$
$t_{\text{rr}}$	Diode Reverse Recovery Time	—	63	95	ns	$T_J = 25^\circ\text{C}$ See Fig.
		—	106	160		$T_J = 125^\circ\text{C}$ 14
$I_{\text{rr}}$	Diode Peak Reverse Recovery Current	—	4.5	8.0	A	$T_J = 25^\circ\text{C}$ See Fig.
		—	6.2	11		$T_J = 125^\circ\text{C}$ 15
$Q_{\text{rr}}$	Diode Reverse Recovery Charge	—	140	380	nC	$T_J = 25^\circ\text{C}$ See Fig.
		—	335	880		$T_J = 125^\circ\text{C}$ 16
$di_{(\text{rec})M}/dt$	Diode Peak Rate of Fall of Recovery During $t_b$	—	133	—	A/ $\mu\text{s}$	$T_J = 25^\circ\text{C}$ See Fig.
		—	85	—		$T_J = 125^\circ\text{C}$ 17



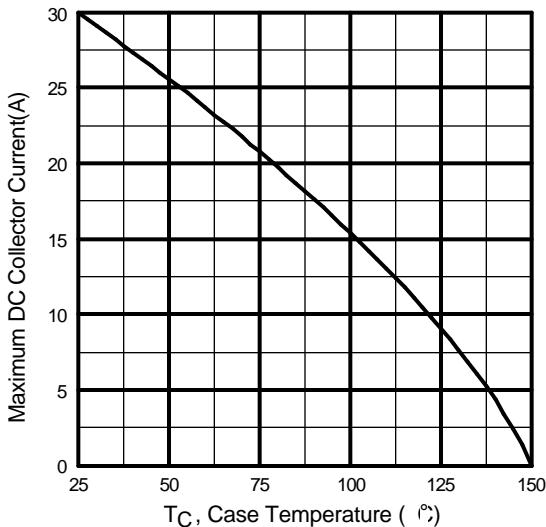
**Fig. 1 - Typical Load Current vs. Frequency**  
(Load Current =  $I_{RMS}$  of fundamental)



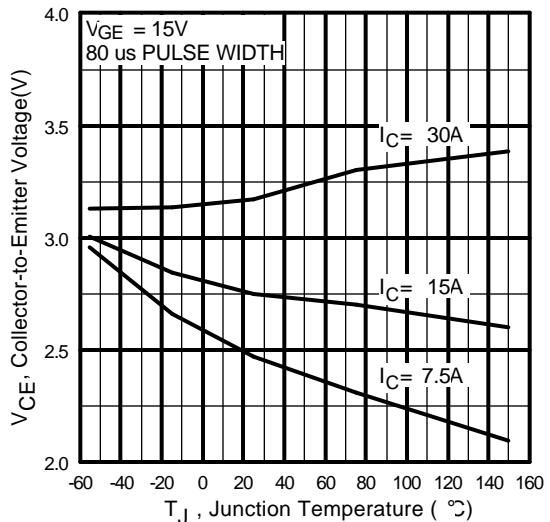
**Fig. 2 - Typical Output Characteristics**



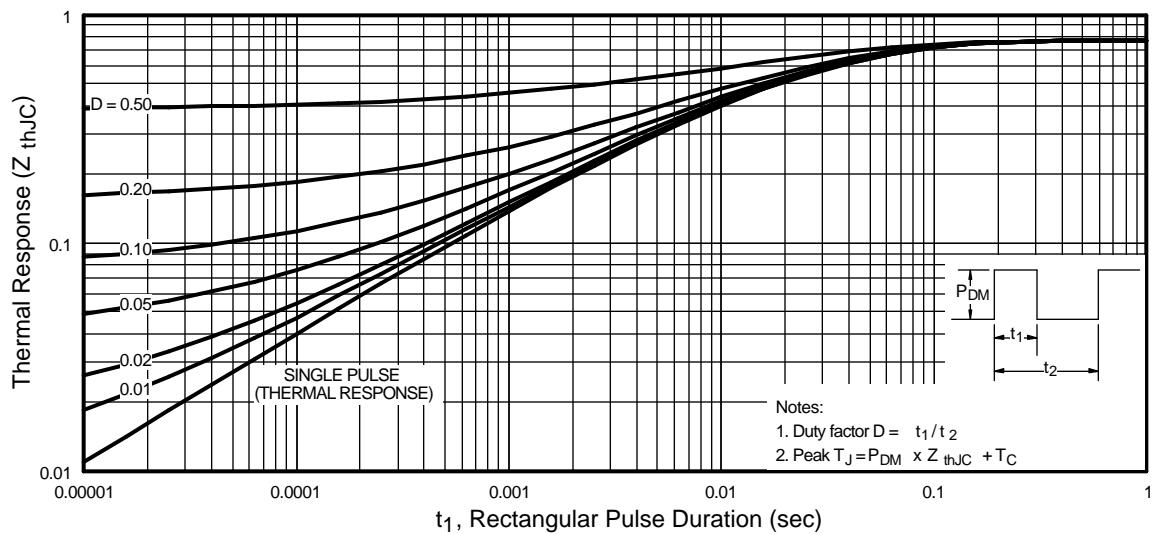
**Fig. 3 - Typical Transfer Characteristics**



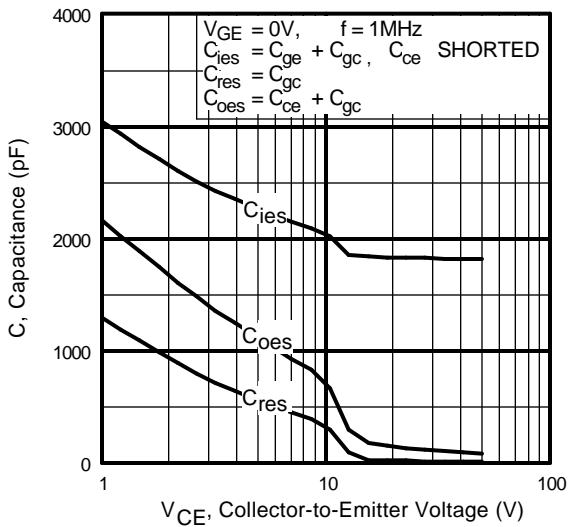
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



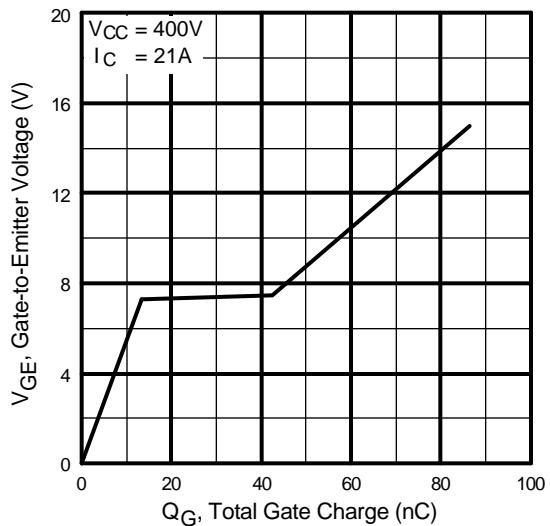
**Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature**



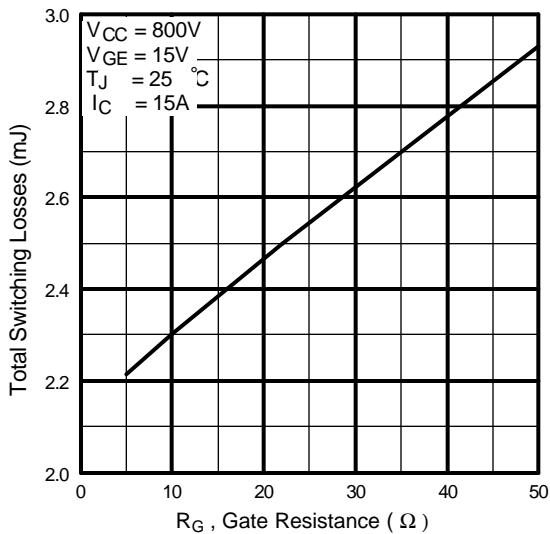
**Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case**



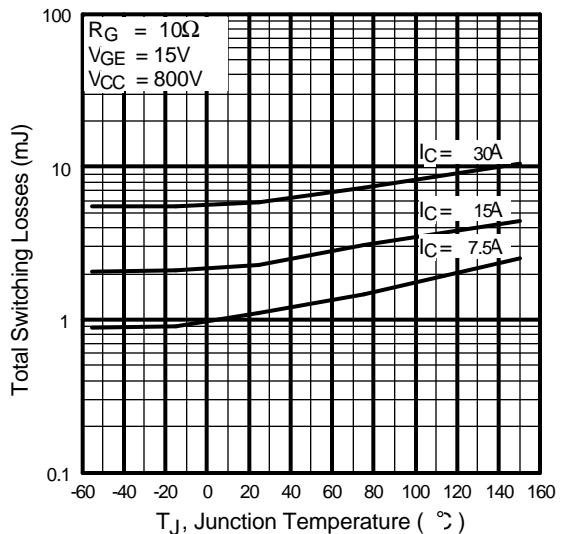
**Fig. 7 - Typical Capacitance vs.  
Collector-to-Emitter Voltage**



**Fig. 8 - Typical Gate Charge vs.  
Gate-to-Emitter Voltage**



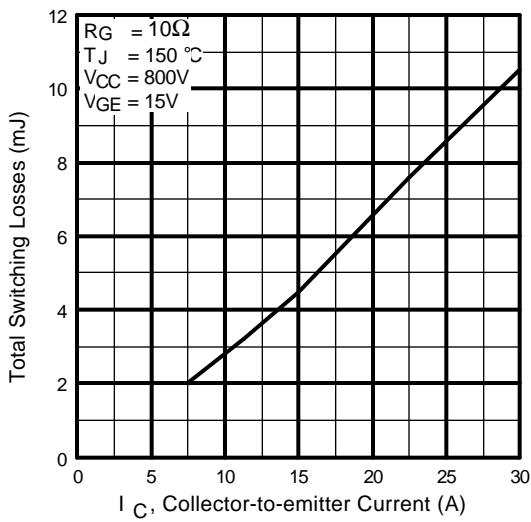
**Fig. 9 - Typical Switching Losses vs. Gate  
Resistance**



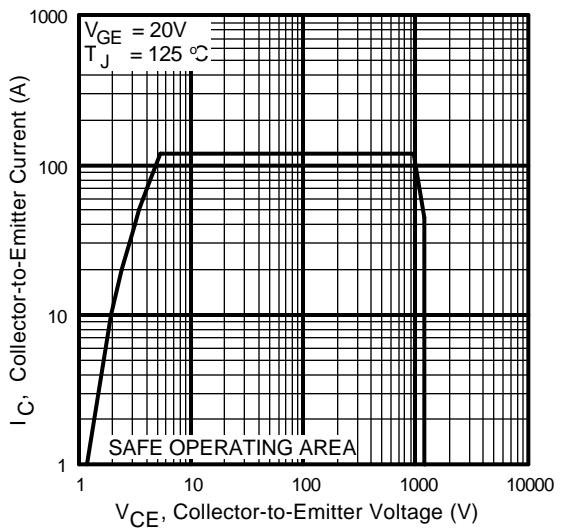
**Fig. 10 - Typical Switching Losses vs.  
Junction Temperature**

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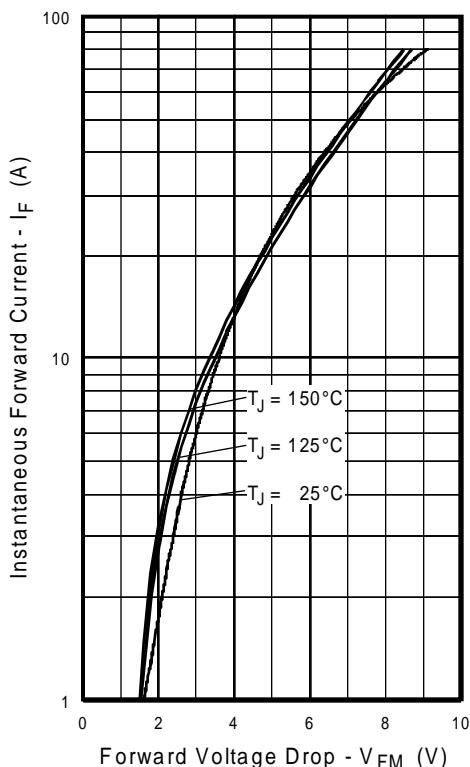
International  
**IR** Rectifier



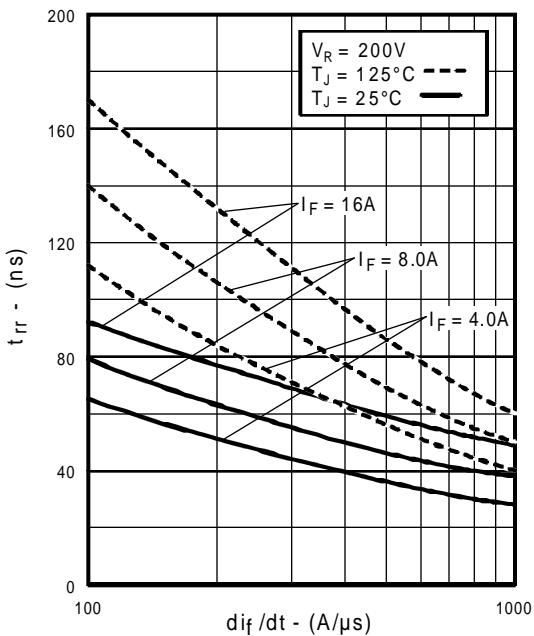
**Fig. 11 - Typical Switching Losses vs.  
Collector-to-Emitter Current**



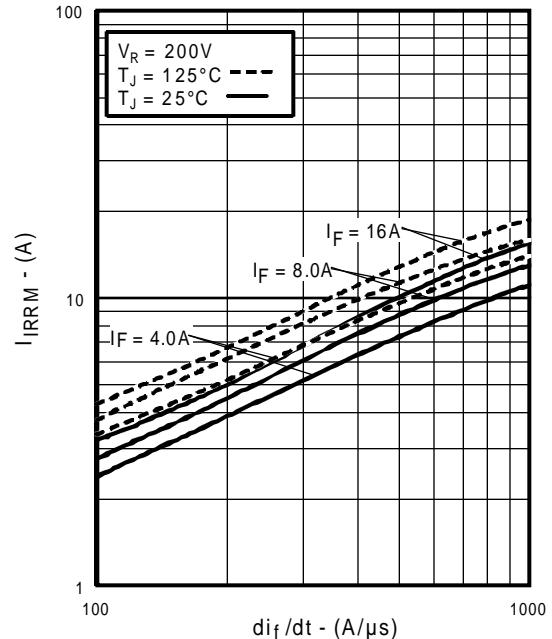
**Fig. 12 - Turn-Off SOA**



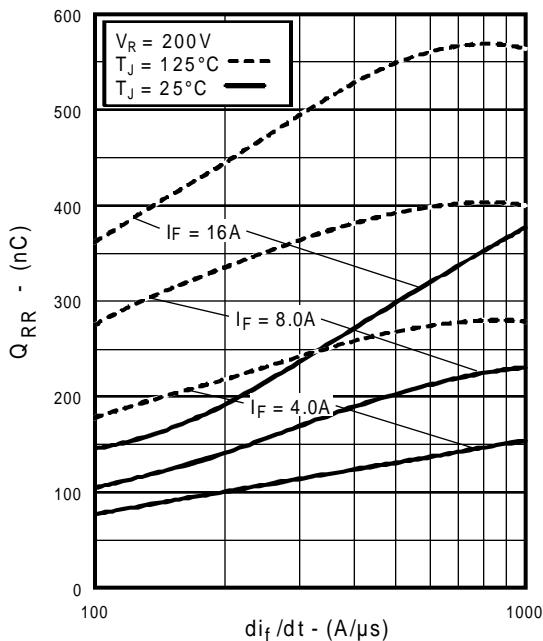
**Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current**



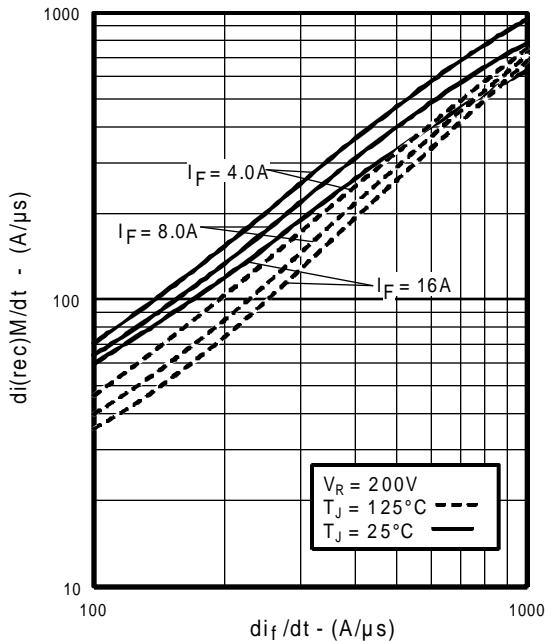
**Fig. 14 - Typical Reverse Recovery vs.  $di_f/dt$**



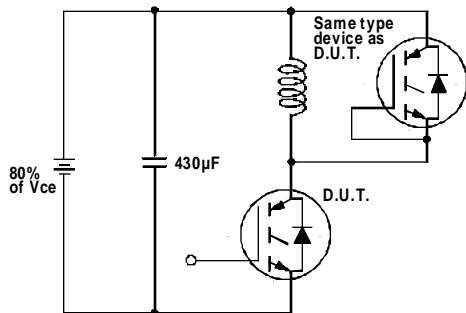
**Fig. 15 - Typical Recovery Current vs.  $di_f/dt$**



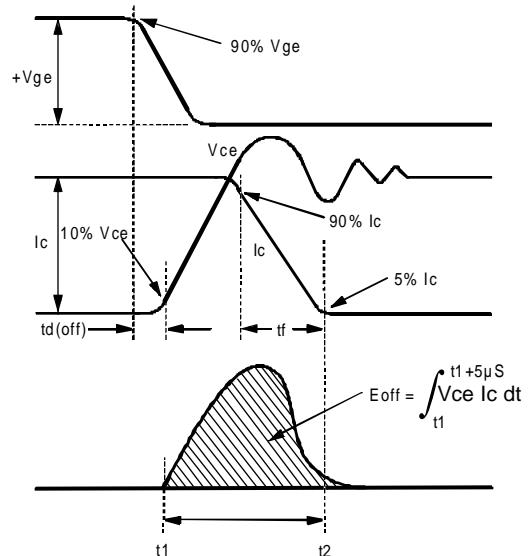
**Fig. 16 - Typical Stored Charge vs.  $di_f/dt$**



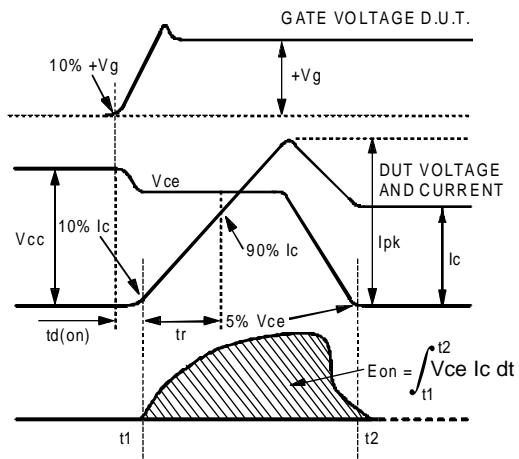
**Fig. 17 - Typical  $di_{(rec)}M/dt$  vs.  $di_f/dt$**



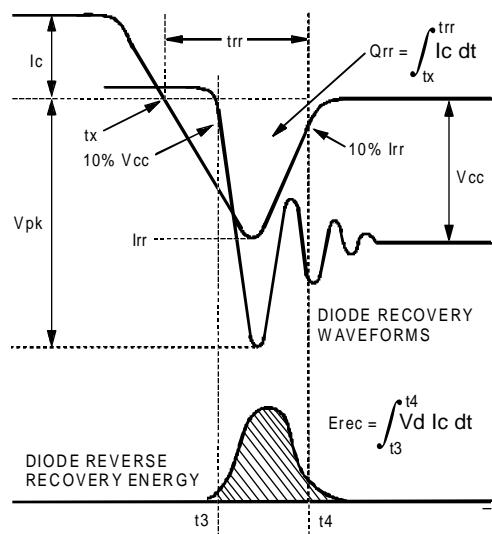
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off(diode)}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_d(on)$ ,  $t_r$ ,  $t_d(off)$ ,  $t_f$



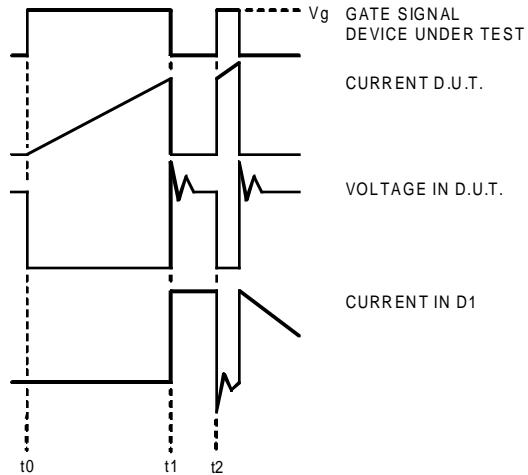
**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



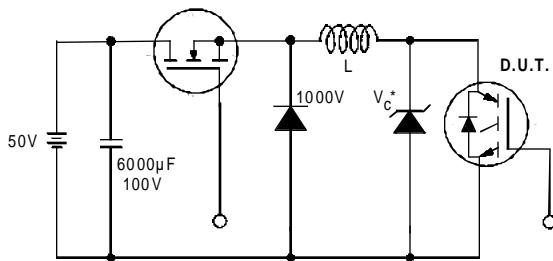
**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



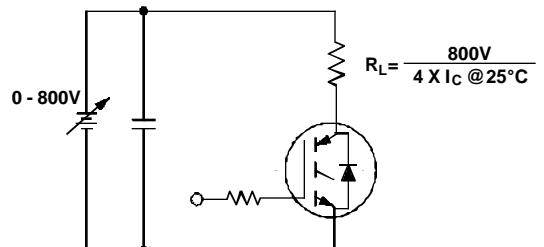
**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$



**Figure 18e.** Macro Waveforms for Figure 18a's Test Circuit



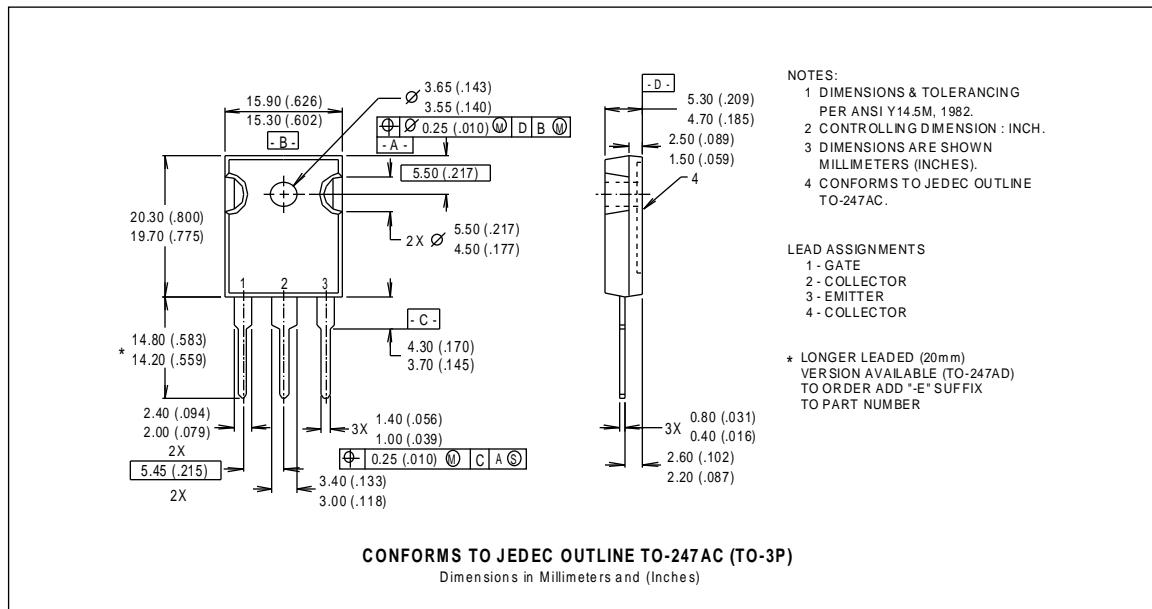
**Figure 19.** Clamped Inductive Load Test Circuit



**Figure 20.** Pulsed Collector Current Test Circuit

**Notes:**

- ① Repetitive rating:  $V_{GE}=20V$ ; pulse width limited by maximum junction temperature (figure 20)
- ②  $V_{CC}=80\% (V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G=5.0\Omega$  (figure 19)
- ③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .
- ④ Pulse width  $5.0\mu s$ , single shot.

**Case Outline — TO-247AC**

International  
**IR** Rectifier

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**IR CANADA:** 7321 Victoria Park Ave., Suite 201, Markham, Ontario L3R 2Z8, Tel: (905) 475 1897

**IR GERMANY:** Saalburgstrasse 157, 61350 Bad Homburg Tel: ++ 49 6172 96590

**IR ITALY:** Via Liguria 49, 10071 Borgaro, Torino Tel: ++ 39 11 451 0111

**IR FAR EAST:** K&H Bldg., 2F, 30-4 Nishi-Ikebukuro 3-Chome, Toshima-Ku, Tokyo Japan 171 Tel: 81 3 3983 0086

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